



<b>Form PTO-1449</b>  <b>LIST OF PATENTS AND PUBLICATIONS FOR APPLICANT'S INFORMATION DISCLOSURE STATEMENT</b>  (Use several sheets if necessary)	<b>ATTORNEY DOCKET NO.</b> 10030377-1	<b>SERIAL NO.</b> 12/687, 225
	<b>APPLICANT</b> Qin et al.	
	<b>FILING DATE</b>	<b>GROUP</b>

REFERENCE DESIGNATION		U.S. PATENT DOCUMENTS		
EXAMINER INITIAL	*	DOCUMENT NUMBER	DATE	NAME

FOREIGN PATENT DOCUMENT					
		DOCUMENT NUMBER	DATE	NAME	TRANSLATION YES NO


OTHER REFERENCES (including Author, Title, Date, Pertinent Pages, etc.)	
	Sutono et al., Experimental Modeling, Repeatability Investigation and Optimization of Microwave Bond Wire Interconnects, IEEE Transactions on Advanced Packaging, Vol. 24, No. 4, 595-603 (November 2001)
	Alpha Industries, Circuit Models for Plastic Packaged Microwave Diodes, Application Note 1001, 1-4 (June 1999)
	Cherry et al., FDTD Analysis of High Frequency Electronic Interconnection Effects, IEEE Transactions on Microwave Theory and Techniques, Vol. 43, No. 10, 2445-51 (October 1995)
<b>EXAMINER</b> 	<b>DATE CONSIDERED</b> 3-14-06


\* Copies of these references are not enclosed Pursuant to 37 CFR 1.98(d). (See accompanying IDS)

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		DOCUMENT NUMBER	DATE	NAME	TRANSLATION YES NO

OTHER REFERENCES (including Author, Title, Date, Pertinent Pages, etc.)	
	Yun et al., Parasitic Impedance Analysis of Double Bonding Wires for High-Frequency Integrated Circuit Packaging, IEEE Microwave and Guided Wave Letters, Vol. 5, No. 9, 296-98 (September 1995)

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